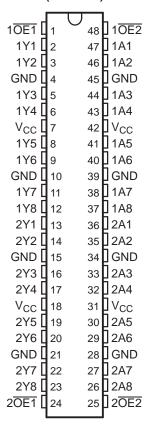
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#### **FEATURES**

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- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art Advanced BiCMOS
   Technology (ABT) Design for 3.3-V Operation and Low Static-Power Dissipation
- Output Ports Have Equivalent 22- $\Omega$  Series Resistors, So No External Resistors Are Required
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V<sub>CC</sub>)
- Support Unregulated Battery Operation Down to 2.7 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- I<sub>off</sub> and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

#### SN54LVTH162541... WD PACKAGE SN74LVTH162541... DGG OR DL PACKAGE (TOP VIEW)



#### DESCRIPTION/ORDERING INFORMATION

These 16-bit buffers/drivers are designed specifically for low-voltage (3.3-V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment.

These devices are noninverting 16-bit buffers composed of two 8-bit sections with separate output-enable signals. For either 8-bit buffer section, the two output-enable (10E1 and 10E2 or 20E1 and 20E2) inputs must be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 8-bit buffer section are in the high-impedance state.

The outputs, which are designed to source or sink up to 12 mA, include equivalent  $22-\Omega$  series resistors to reduce overshoot and undershoot.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.

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### **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

The SN54LVTH162541 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LVTH162541 is characterized for operation from –40°C to 85°C.

#### **ORDERING INFORMATION**

| T <sub>A</sub> | PACKAGE <sup>(1)</sup> |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |  |  |
|----------------|------------------------|--------------|-----------------------|------------------|--|--|
|                |                        | Reel of 1000 | 74LVTH162541DLRG4     |                  |  |  |
|                | CCOD DI                | Reel of 1000 | SN74LVTH162541DLR     | 11/71/400544     |  |  |
| 400C to 050C   | SSOP – DL              | Tube of 25   | LVTH162541            |                  |  |  |
| –40°C to 85°C  |                        |              | SN74LVTH162541DL      |                  |  |  |
|                | TSSOP – DGG            | Reel of 2000 | 74LVTH162541DGGRE4    | LVTH162541       |  |  |
|                | 1330P – DGG            | Reel of 2000 | SN74LVTH162541DGGR    | LV1H102541       |  |  |

<sup>(1)</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

# FUNCTION TABLE (each 8-bit section)

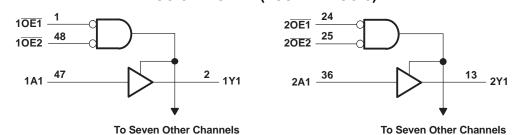
|     | INPUTS |   |   |  |  |  |  |
|-----|--------|---|---|--|--|--|--|
| OE1 | OE2    | Α | Y |  |  |  |  |
| L   | L      | L | L |  |  |  |  |
| L   | L      | Н | Н |  |  |  |  |
| Н   | X      | X | Z |  |  |  |  |
| X   | Н      | X | Z |  |  |  |  |



#### LOGIC SYMBOL<sup>(1)</sup> 1 10E1 48 EN1 10E2 24 & 20E1 EN2 25 20E2 47 2 1Y1 1A1 1 ▽ 3 46 1A2 1Y2 5 1Y3 1A3 43 6 1A4 1Y4 8 1A5 1Y5 40 9 1A6 1Y6 38 11 1A7 1Y7 37 12 1A8 1Y8 13 36 2 ▽ 2A1 1 2Y1 35 14 2A2 2Y2 33 16 2A3 2Y3 32 17 2A4 2Y4 30 19 2Y5 2A5 29 20 2A6 27 22 2A7 2Y7 26 23 2A8 2Y8

(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### **LOGIC DIAGRAM (POSITIVE LOGIC)**



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### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |                                                 |                                              | MIN  | MAX            | UNIT |
|------------------|-------------------------------------------------|----------------------------------------------|------|----------------|------|
| $V_{CC}$         | Supply voltage range                            |                                              | -0.5 | 4.6            | V    |
| $V_{I}$          | Input voltage range <sup>(2)</sup>              |                                              | -0.5 | 7              | V    |
| $V_{O}$          | Voltage range applied to any output in the high | -impedance or power-off state <sup>(2)</sup> | -0.5 | 7              | V    |
| Vo               | Voltage range applied to any output in the high | state (2)                                    | -0.5 | $V_{CC} + 0.5$ | V    |
| Io               | Current into any output in the low state        |                                              | 30   | mA             |      |
| Io               | Current into any output in the high state (3)   |                                              | 30   | mA             |      |
| I <sub>IK</sub>  | Input clamp current                             | V <sub>I</sub> < 0                           |      | -50            | mA   |
| I <sub>OK</sub>  | Output clamp current                            | V <sub>O</sub> < 0                           |      | -50            | mA   |
| 0                | Package thermal impedance <sup>(4)</sup>        | DGG package                                  |      | 89             | °C/W |
| $\theta_{JA}$    | rackage mermai impedance vii                    | DL package                                   |      | 94             | C/VV |
| T <sub>stg</sub> | Storage temperature range                       |                                              | -65  | 150            | °C   |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### Recommended Operating Conditions<sup>(1)</sup>

|                          |                                    |                 | SN54LVTH | 162541 | SN74LVTH | 162541 | LINUT |
|--------------------------|------------------------------------|-----------------|----------|--------|----------|--------|-------|
|                          |                                    |                 | MIN      | MAX    | MIN      | MAX    | UNIT  |
| V <sub>CC</sub>          | Supply voltage                     |                 | 2.7      | 3.6    | 2.7      | 3.6    | V     |
| V <sub>IH</sub>          | High-level input voltage           |                 | 2        |        | 2        |        | V     |
| $V_{IL}$                 | Low-level input voltage            |                 | 8.0      |        | 0.8      | V      |       |
| VI                       | Input voltage                      | Input voltage   |          |        |          | 5.5    | V     |
| I <sub>OH</sub>          | High-level output current          |                 |          | -12    |          | -12    | mA    |
| I <sub>OL</sub>          | Low-level output current           |                 |          | 12     |          | 12     | mA    |
| Δt/Δν                    | Input transition rise or fall rate | Outputs enabled |          | 10     |          | 10     | ns/V  |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 | ·               | 200      |        | 200      |        | μs/V  |
| T <sub>A</sub>           | Operating free-air temperature     |                 | -55      | 125    | -40      | 85     | °C    |

All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

 <sup>(2)</sup> The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 (3) This current flows only when the output is in the high state and V<sub>O</sub> > V<sub>CC</sub>.
 (4) The package thermal impedance is calculated in accordance with JESD 51.



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### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| Б.                    | DAMETER                                                              | TECT                                                                  | CONDITIONS                                   | SN  | 54LVTH162          | 2541                | SN7 | 4LVTH162           | 2541        | LINUT |  |
|-----------------------|----------------------------------------------------------------------|-----------------------------------------------------------------------|----------------------------------------------|-----|--------------------|---------------------|-----|--------------------|-------------|-------|--|
| PA                    | RAMETER                                                              | IESI                                                                  | CONDITIONS                                   | MIN | TYP <sup>(1)</sup> | MAX                 | MIN | TYP <sup>(1)</sup> | MAX         | UNIT  |  |
| $V_{IK}$              |                                                                      | $V_{CC} = 2.7 \text{ V},$                                             | $I_1 = -18 \text{ mA}$                       |     |                    | -1.2                |     |                    | -1.2        | V     |  |
| V <sub>OH</sub>       |                                                                      | $V_{CC} = 3 V$ ,                                                      | $I_{OH} = -12 \text{ mA}$                    | 2   |                    |                     | 2   |                    |             | V     |  |
| V <sub>OL</sub>       |                                                                      | $V_{CC} = 3 V$ ,                                                      | I <sub>OL</sub> = 12 mA                      |     |                    | 0.8                 |     |                    | 8.0         | V     |  |
|                       |                                                                      | $V_{CC} = 0 \text{ or } 3.6 \text{ V},$                               | V <sub>I</sub> = 5.5 V                       |     |                    | 10                  |     |                    | 10          |       |  |
| I <sub>I</sub>        | Control inputs                                                       | V <sub>CC</sub> = 3.6 V,                                              | $V_I = V_{CC}$ or GND                        |     |                    | ±1                  |     |                    | ±1          |       |  |
|                       | Data innuta                                                          | V <sub>CC</sub> = 3.6 V                                               | $V_I = V_{CC}$                               |     |                    | 1                   |     |                    | 1           |       |  |
|                       | Data inputs                                                          | v <sub>CC</sub> = 3.6 v                                               | $V_I = 0$                                    |     |                    | -5                  |     |                    | <b>-</b> 5  |       |  |
| I <sub>off</sub>      |                                                                      | $V_{CC} = 0$ ,                                                        | $V_I$ or $V_O = 0$ to 4.5 V                  |     |                    |                     |     |                    | ±100        | μΑ    |  |
|                       | Data inputs $\frac{V_{CC} = 3 \text{ V}}{V_{CC} = 3.6 \text{ V}, 0}$ | \/ - 3 \/                                                             | $V_{I} = 0.8 V$                              | 75  |                    |                     | 75  |                    |             |       |  |
| Ira I-n               |                                                                      | v <sub>CC</sub> = 3 v                                                 | V <sub>I</sub> = 2 V                         | -75 |                    |                     | 75  |                    |             | μΑ    |  |
| 'I(noia)              |                                                                      | V <sub>CC</sub> = 3.6 V, <sup>(2)</sup>                               | V <sub>I</sub> = 0 to 3.6 V                  |     |                    |                     |     |                    | 500<br>-750 |       |  |
| I <sub>OZH</sub>      |                                                                      | V <sub>CC</sub> = 3.6 V,                                              | V <sub>O</sub> = 3 V                         |     |                    | 5                   |     |                    | 5           | μΑ    |  |
| I <sub>OZL</sub>      |                                                                      | $V_{CC} = 3.6 \text{ V},$                                             | $V_0 = 0.5 V$                                |     |                    | -5                  |     |                    | <b>-</b> 5  | μΑ    |  |
| I <sub>OZPU</sub>     |                                                                      | $\frac{V_{CC}}{OE} = 0$ to 1.5 V, $V_{CC}$                            | $_{0}$ = 0.5 V to 3 V,                       |     |                    | ±100 <sup>(3)</sup> |     |                    | ±100        | μΑ    |  |
| I <sub>OZPD</sub>     |                                                                      | $\frac{V_{CC}}{OE}$ = 1.5 V to 0, $V_{CC}$                            | <sub>0</sub> = 0.5 V to 3 V,                 |     |                    | ±100 <sup>(3)</sup> |     |                    | ±100        | μΑ    |  |
|                       |                                                                      | V <sub>CC</sub> = 3.6 V,                                              | Outputs high                                 |     |                    | 0.19                |     |                    | 0.19        |       |  |
| $I_{CC}$              |                                                                      | $I_{O} = 0$ ,                                                         | Outputs low                                  |     |                    | 5                   |     |                    | 5           | mA    |  |
|                       |                                                                      | $V_I = V_{CC}$ or GND                                                 | Outputs disabled                             |     |                    | 0.19                |     |                    | 0.19        |       |  |
| $\Delta I_{CC}^{(4)}$ |                                                                      | $V_{CC} = 3 \text{ V to } 3.6 \text{ V},$<br>Other inputs at $V_{CC}$ | One input at V <sub>CC</sub> – 0.6 V, or GND |     |                    | 0.2                 |     |                    | 0.2         | mA    |  |
| Ci                    |                                                                      | $V_I = 3 V \text{ or } 0$                                             |                                              |     | 4                  |                     |     | 4                  |             | pF    |  |
| Co                    |                                                                      | V <sub>O</sub> = 3 V or 0                                             |                                              |     | 9                  |                     |     | 9                  |             | pF    |  |

All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to

On products compliant to MIL-PRF-38535, this parameter is not production tested.

This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V<sub>CC</sub> or GND.

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### **Switching Characteristics**

over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

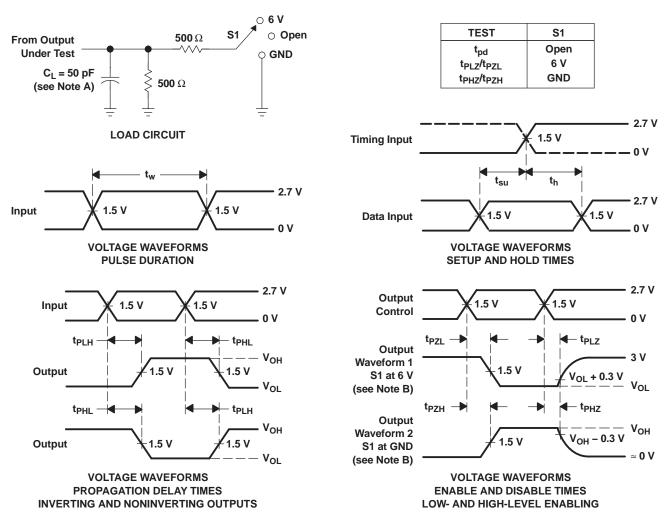
|                     | FROM<br>(INPUT) | TO<br>(OUTPUT) | SN                           | 154LVTI                      | H162541 |                          |     | SN74L                        | .VTH162 | 2541 |                         |     |
|---------------------|-----------------|----------------|------------------------------|------------------------------|---------|--------------------------|-----|------------------------------|---------|------|-------------------------|-----|
| PARAMETER           |                 |                | V <sub>CC</sub> = 3<br>± 0.3 | $V_{CC}$ = 3.3 V $\pm$ 0.3 V |         | $V_{CC} = 2.7 \text{ V}$ |     | $V_{CC}$ = 3.3 V $\pm$ 0.3 V |         |      | V <sub>CC</sub> = 2.7 V |     |
|                     |                 |                | MIN                          | MAX                          | MIN     | MAX                      | MIN | TYP <sup>(1)</sup>           | MAX     | MIN  | MAX                     |     |
| t <sub>PLH</sub>    | Α               | Υ              | 1.1                          | 4.3                          |         | 4.9                      | 1.2 | 2.9                          | 4.1     |      | 4.7                     | ns  |
| t <sub>PHL</sub>    | A               |                | 1.1                          | 4.3                          |         | 4.9                      | 1.2 | 2.4                          | 4.1     |      | 4.7                     | 115 |
| t <sub>PZH</sub>    | ŌĒ              | <b>&gt;</b>    | 1.4                          | 5.3                          |         | 6.3                      | 1.5 | 3.2                          | 5       |      | 6.1                     | ns  |
| t <sub>PZL</sub>    | OL              | Ť              | 1.4                          | 5.1                          |         | 5.8                      | 1.5 | 3.3                          | 4.8     |      | 5.5                     | 113 |
| t <sub>PHZ</sub>    | ŌĒ              | Υ              | 2.1                          | 6.1                          |         | 6.4                      | 2.2 | 4.3                          | 5.9     |      | 6.2                     | no  |
| t <sub>PLZ</sub>    | OE              | r              | 2.1                          | 5.7                          |         | 5.9                      | 2.2 | 4                            | 5.4     |      | 5.5                     | ns  |
| t <sub>sk(LH)</sub> |                 |                |                              |                              |         |                          |     |                              | 0.5     |      | 0.5                     | ns  |
| t <sub>sk(HL)</sub> |                 |                |                              |                              |         |                          |     | ·                            | 0.5     |      | 0.5                     | 115 |

<sup>(1)</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C.





#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>1</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{O}$  = 50  $\Omega$ ,  $t_{f} \leq$  2.5 ns,  $t_{f} \leq$  2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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#### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins   | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|------------------|-----------------------|------|-------------------------------|----------------------------|--------------|--------------|
|                       | (1)    | (2)           |                  |                       | (3)  | (4)                           | (5)                        |              | (6)          |
| SN74LVTH162541DGGR    | Active | Production    | TSSOP (DGG)   48 | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | LVTH162541   |
| SN74LVTH162541DGGR.B  | Active | Production    | TSSOP (DGG)   48 | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | LVTH162541   |
| SN74LVTH162541DL      | Active | Production    | SSOP (DL)   48   | 25   TUBE             | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | LVTH162541   |
| SN74LVTH162541DL.B    | Active | Production    | SSOP (DL)   48   | 25   TUBE             | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | LVTH162541   |
| SN74LVTH162541DLR     | Active | Production    | SSOP (DL)   48   | 1000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | LVTH162541   |
| SN74LVTH162541DLR.B   | Active | Production    | SSOP (DL)   48   | 1000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | LVTH162541   |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



### **PACKAGE OPTION ADDENDUM**

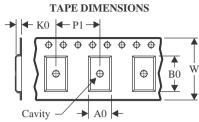
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### **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|-----------------------------------------------------------|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

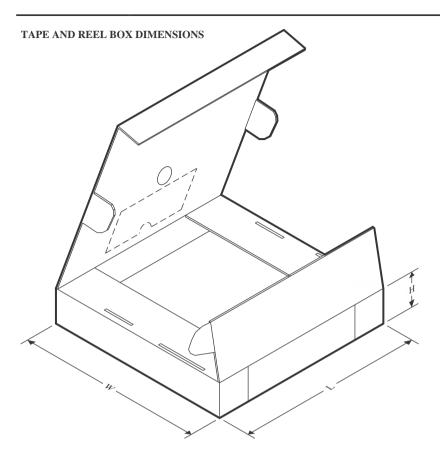
### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device             | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LVTH162541DGGR | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 13.0       | 1.8        | 12.0       | 24.0      | Q1               |
| SN74LVTH162541DLR  | SSOP            | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |

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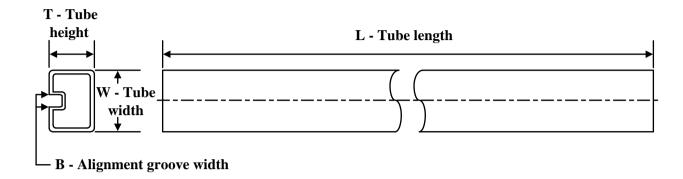
### \*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVTH162541DGGR | TSSOP        | DGG             | 48   | 2000 | 356.0       | 356.0      | 45.0        |
| SN74LVTH162541DLR  | SSOP         | DL              | 48   | 1000 | 356.0       | 356.0      | 53.0        |

### **PACKAGE MATERIALS INFORMATION**

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### **TUBE**



### \*All dimensions are nominal

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74LVTH162541DL   | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |
| SN74LVTH162541DL.B | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |

## DL (R-PDSO-G48)

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

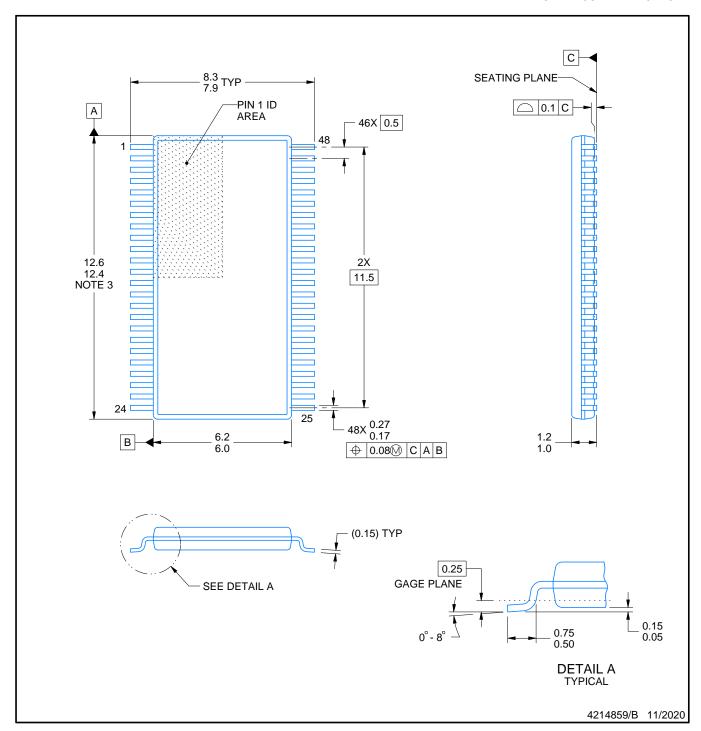
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.





SMALL OUTLINE PACKAGE



### NOTES:

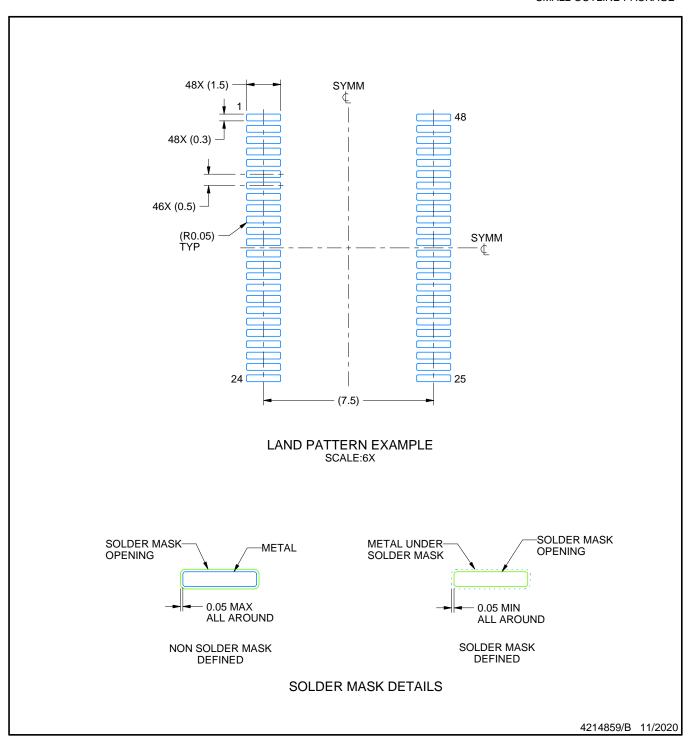
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-153.



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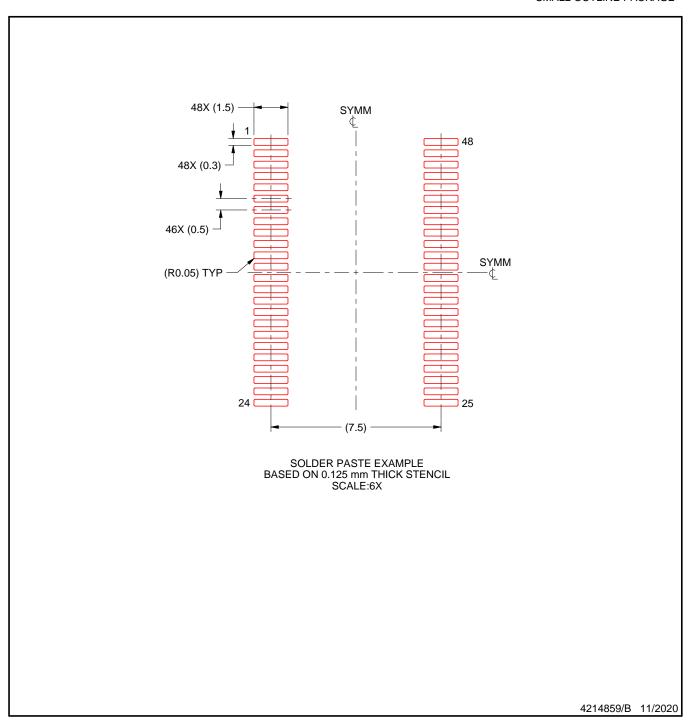


NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



### DGG (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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